# HEAT DISSIPATORS FOR PLASTIC CASE, CASE-MOUNTED SEMICONDUCTORS

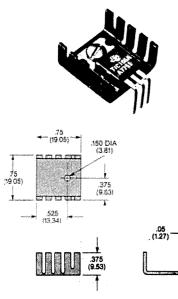
### Horizontally mounted, light-weight, low-cost heat dissipators

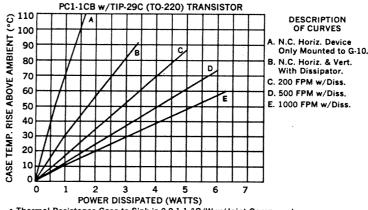
- Accommodates all flat plastic case power semiconductors.
- Efficient design requires just .71 sq. in. of board area (PA Series) and .31" to .5" height above board.
- Larger PB Series offers greater heat dissipation, additional hole patterns, and dual semiconductor mounting capability.

• Only one mounting screw required to secure dissipators to semiconductor and circuit board.

Most effective heat dissipator in performance/unit cost.

PC1-1CB



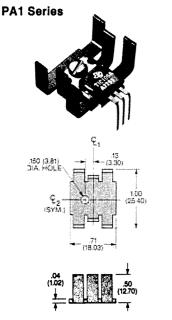


• Thermal Resistance Case to Sink is 0.9-1.1 °C/W w/Joint Compound. Derate 2.4 °C/watt for unplated part in natural convection only.

#### **Ordering Information**

.375 (9.53)

|          | IERC PART NO.            | Samlaandustar         | Max.                          |                   |
|----------|--------------------------|-----------------------|-------------------------------|-------------------|
| Unplated | Comm'l. Black<br>Anodize | Mil. Black<br>Anodize | Semiconductor<br>Accommodated | Weight<br>(Grams) |
| PC1-1U   | PC1-1CB                  | PC1-1B                | T0-126,<br>T0-127,<br>T0-220  | 1.9               |



Dimensions are for reference use only. Contact IERC for dimensions with tolerances or standard part drawings.

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PA1-1U w/TIP-29C (TO-220) TRANSISTOR DESCRIPTION OF CURVES A. N.C. Horiz, Device Only Mounted to G-10. D B. N.C. Horiz. & Vert. With Dissipator. C. 200 FPM w/Diss. D. 500 FPM w/Diss. E. 1000 FPM w/Diss. 0 0 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 POWER DISSIPATED (WATTS) Thermal Resistance Case to Sink is 0.9-1.1 °C/W w/Joint Compound.
Uprate 2.4 °C/watt for black part in natural convection only.
Derate 0.6 °C/watt for Insulube® part in natural convection only.

#### **Ordering Information**

| IERC PART NO.  |                         |                       |                  |  | Max.              |
|----------------|-------------------------|-----------------------|------------------|--|-------------------|
| Unplated       | Com'l. Black<br>Anodize | Mil. Black<br>Anodize | Insulube®<br>448 | Semiconductor<br>Accommodated          | Weight<br>(Grams) |
| PA1U<br>PA1-1U | PA1CB<br>PA1-1CB        | PA1B<br>PA1-1B        | PA1<br>PA1-1     | Undrilled<br>T0-126, T0-127,<br>T0-220 | 2.0<br>2.0        |

Note: See page ly for other finishes.

## **Mouser Electronics**

Authorized Distributor

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CTS: PA1-1CB PC1-1CB